



100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
100V	22mΩ @ V _{GS} = 10V	51.7A
	30mΩ @ V _{GS} = 6V	44.3A
	43.7mΩ @ V _{GS} = 4.5V	36.7A

Description

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Power-management functions
- DC-DC converters
- Backlighting

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Rds(ON) Minimizes Power Losses
- Low Q_G Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H025LK3Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

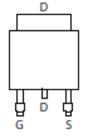
https://www.diodes.com/quality/product-definitions/

Mechanical Data

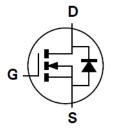
- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.33 grams (Approximate)







Pin Out Top View



Equivalent Circuit

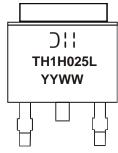
Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Part Number	Package	Qty.	Carrier	
DMTH10H025LK3Q-13	TO252 (DPAK)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Dil = Manufacturer's Marking
TH1H025L = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	100	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) T_{C} T_{C}		l _D	51.7 36.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	95	A	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	51.7	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	95	Α	
Avalanche Current, L = 0.1mH	I _{AS}	15.8	Α	
Avalanche Energy, L = 0.1mH	Eas	12.5	mJ	

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	3.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	48	°C/W
Total Power Dissipation (Note 6)		PD	100	W
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

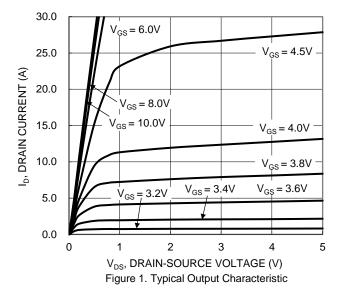
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	100	_	_	V	$V_{GS} = 0$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 80V, V _{GS} = 0	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0$	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		_	17.1	22		$V_{GS} = 10V, I_{D} = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	21.4	30	mΩ	$V_{GS} = 6V, I_D = 20A$	
		_	28.3	43.7		$V_{GS} = 4.5V, I_{D} = 20A$	
Diode Forward Voltage	VsD	_	_	1.3	V	V _{GS} = 0, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	1477	_		V _{DS} = 50V, V _{GS} = 0, f = 1MHz	
Output Capacitance	Coss	_	263	_	pF		
Reverse Transfer Capacitance	Crss	_	20	_		1 – 11011 12	
Gate Resistance	Rg	_	1.3	_	Ω	$V_{DS} = 0$, $V_{GS} = 0$, $f = 1MHz$	
Total Gate Charge	Q_{G}	_	21	_		V _{DD} = 50V, I _D = 20A, V _{GS} = 10V	
Gate-Source Charge	Qgs	_	5.7	_	nC		
Gate-Drain Charge	Q _{GD}	_	3.8	_			
Turn-On Delay Time	td(ON)	_	6.3	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 6\Omega$	
Turn-On Rise Time	t _R	_	9.4	_	ns		
Turn-Off Delay Time	tD(OFF)	_	16.7	_	115		
Turn-Off Fall Time	tF	_	8.2	_			
Reverse-Recovery Time	t _{RR}	_	38.7	_	ns	I_ 201 di/dt 1001/us	
Reverse-Recovery Charge	Qrr	_	53.7	_	nC	I _F = 20A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.







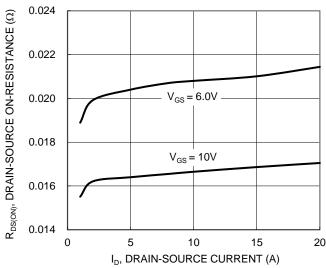


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

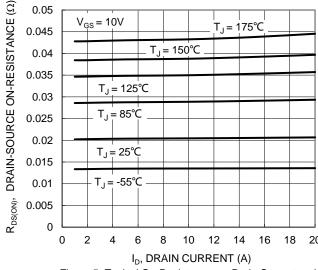


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

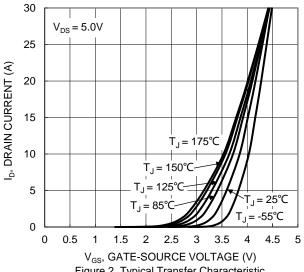


Figure 2. Typical Transfer Characteristic

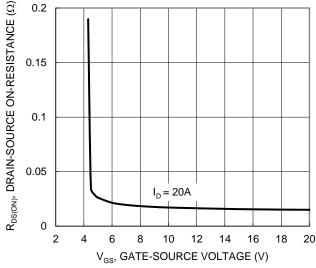


Figure 4. Typical Transfer Characteristic

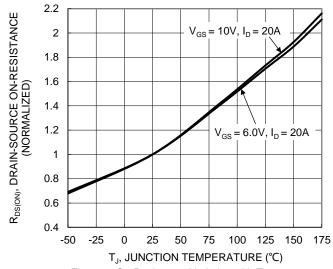


Figure 6. On-Resistance Variation with Temperature





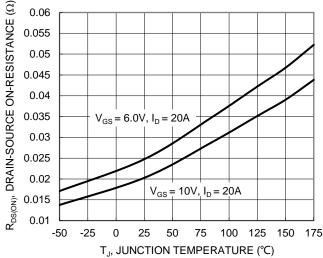


Figure 7. On-Resistance Variation with Temperature

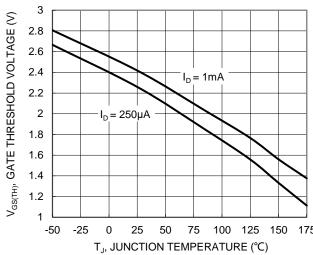


Figure 8. Gate Threshold Variation vs. Junction Temperature

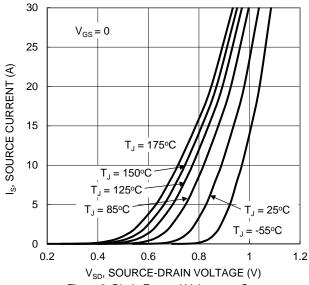
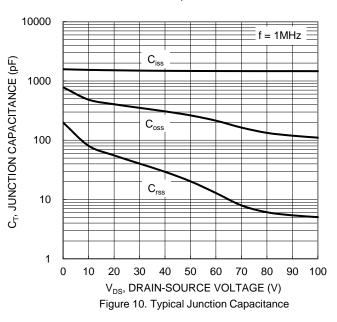
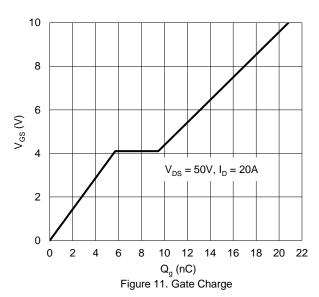
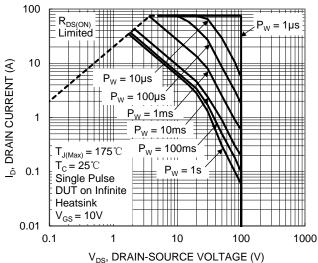


Figure 9. Diode Forward Voltage vs. Current









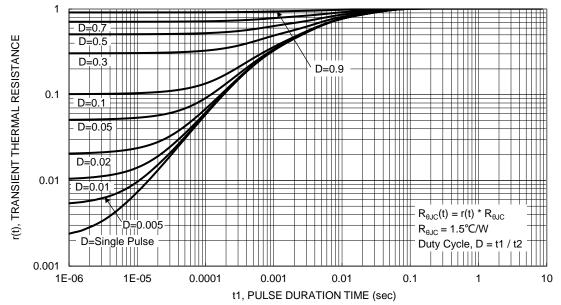


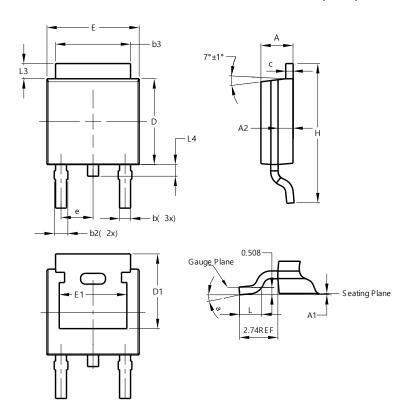
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

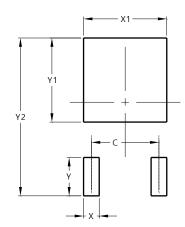


TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.50	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21				
е	2.	2.286 BSC			
Е	6.45	6.70	6.58		
E1	4.32				
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)			
С	4.572			
Х	1.060			
X1	5.632			
Y	2.600			
Y1	5.700			
Y2	10 700			



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